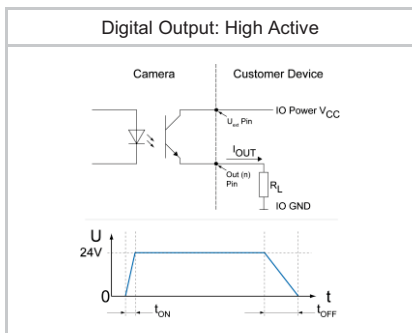
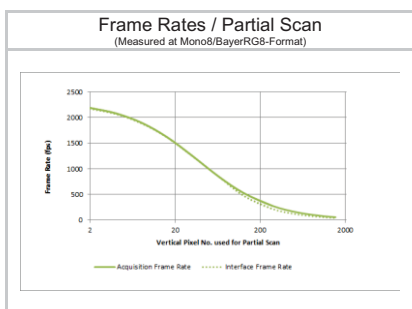
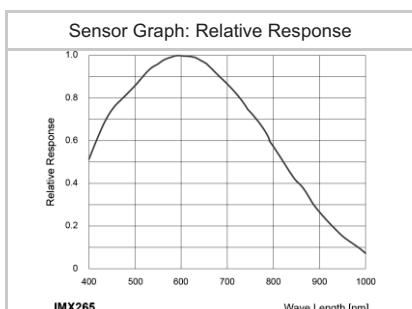




Sensor Information

Model Name	Sony IMX265
Type	1/1.8" progressive scan CMOS
Shutter	Global Shutter
Resolution	2048 × 1536 pixels
Scan Area	7.07 mm x 5.30 mm
Pixel Size	3.45 µm x 3.45 µm

Data Quality

@ 20 °C, gain = 1, exposure time = 4 msec

Dark Noise (σ)	2 e- typical
Saturation	9500 e- typical
Dynamic Range	71 dB typical
SNR	40 dB typical
Quantum efficiency η	67,3% @ 536 nm typical

Acquisition

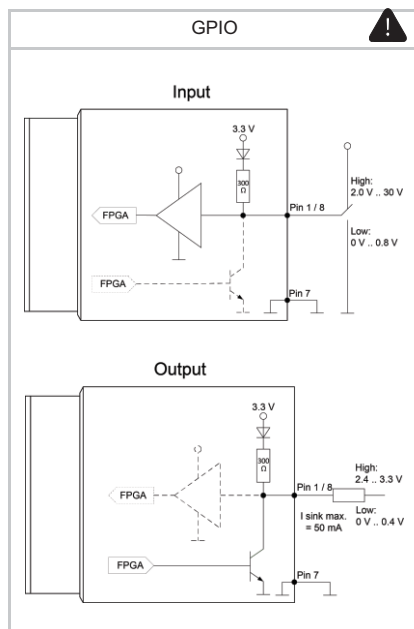
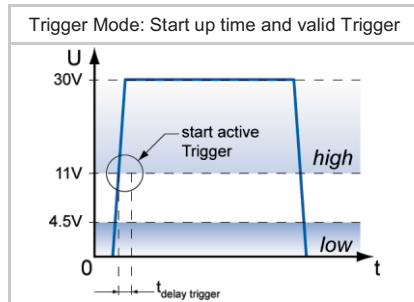
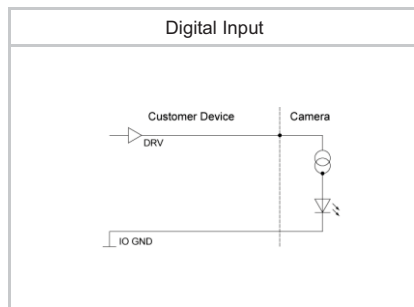
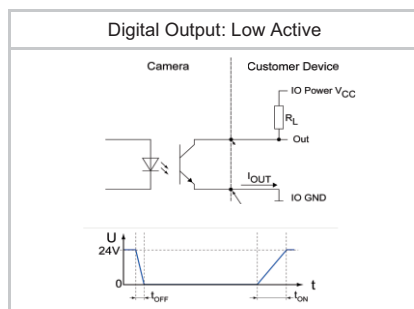
Resolution	2048 px x 1536 px		
Interface Frame Rate (depends on used interface performance)	Format	Resolution	max. Frame Rate (@ Trigger Mode) ²⁾
	Full Frame	2048 x 1536	39 fps
	Binning 2x2	1024 x 768	56 fps
	Binning 2x1	1024 x 1536	56 fps
	Binning 1x2	2048 x 768	56 fps
Acquisition Frame Rate ¹⁾ (Burst Mode)	56 fps $t_{\text{readout}} = 17.8 \text{ msec}$ (max. Res. Full Frame) @ 12 bit		
Pixel Formats	Mono8, Mono10, Mono12, Mono12p		
Partial Scan	True Partial Scan with increasing Frame Rate on Y direction, Region of Interest (ROI) arbitrary Width: minimum 16, increment 16 Height: minimum 2, increment 2		
Adjustable Acquisition Frame Rate	Off or Off or 0.01 ... 2212 Hz		
Acquisition Mode	Continuous, Single Frame and Multi Frame		
Acquisition Status	AcquisitionActive, AcquisitionTrigger Wait		
Exposure Mode	Timed		
Readout Mode	Overlapped, Sequential		

Image Pre-Processing

Analog Controls	Exposure Time (1 µsec ... 60 sec Step Size 1 µsec) Gain (0...48 dB), Offset (0 ... 255 LSB 12 bit)
Gamma Correction	Gamma (0.1 ... 2 available if LUT is enabled)
LUT	Luminance (12 bit)
Color Models	Mono
Color Processing	-
Color Adjustment	-
Color Enhancement	-
Color Tolerance	-
Binning Horizontal	1 or 2
Binning Vertical	1 or 2
Image Flipping	Horizontal, vertical
Defect Pixel Correction	via Defect Pixel List with up to 512 Pixel Coordinates
Fix Pattern Noise	-
Correction	-

¹⁾ Sensor readout, different from pixel format

²⁾ depends on the used interface



¹⁾ Sensor readout, different from pixel format

Process Synchronization

Trigger Mode	Off (Free Running), On (Trigger)
Trigger Overlap Type	Readout
Trigger Sources	Hardware (Line0,1,2), Software, All, ActionCMD (Action 1) or Off fixed Trigger Delay out of t _{readout} : ¹⁾ 66.7 μsec @ 12 bit max. Trigger Delay during t _{readout} : ¹⁾ 73.1 μsec @ 12 bit
Trigger Delay	0 ... 2 sec, Tracking and buffering of up to 256 triggers
External Flash Sync	via Exposure Active t _{delay flash} ≤ 3 μsec, t _{duration} = t _{exposure}

Digital I/Os

Lines	Input: Line 0, Output: Line3, GPIO: Line 1, Line 2
Output Sources	Off, ExposureActive, Timer1, ReadoutActive, UserOutput 1-3 and TriggerReady
Line Debouncer	Low and high signal separately selectable Debouncing Time 0 ... 5 msec, Step Size: 1 μsec

Memory

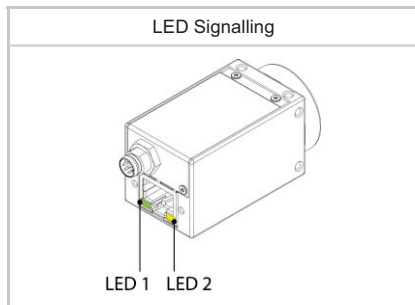
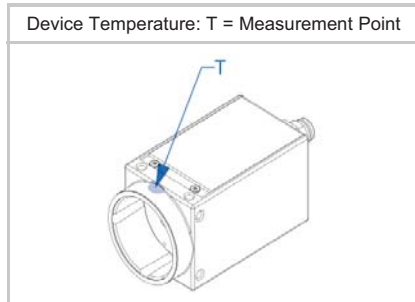
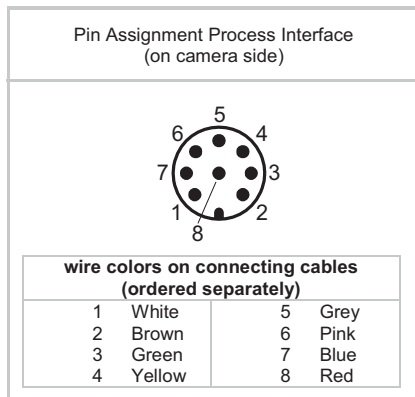
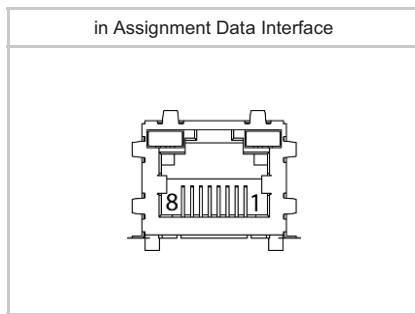
Image Buffer	72 MB 8 Images (Trigger Mode) / 1 Image (Free Running Mode)
Non-volatile Memory	128 kb

Network Interface Data

Interface	Gigabit Ethernet 1000BASE-T 1000 Mbits/sec Fast Ethernet 100 BASE-T 100 Mbits/sec
Ethernet IP Configuration	Persistent IP, DHCP, LLA
Packet Size	576 ... 9000 Byte, Jumbo Frames supported

GigE Vision® Features

Events	DeviceTemperatureStatusChanged, EventLost, ExposureEnd, ExposureStart, FrameEnd, FrameStart, FrameTransferSkipped, Error, GigEVisionHeartbeatTimeOut, Line0..3 FallingEdge, Line0..3 RisingEdge, PrimaryApplicationSwitch, TransferBufferFull, TransferBufferReady, TriggerOverlapped, TriggerReady, TriggerSkipped
Action CMD	yes, Action 1 for Trigger
Frame Counter	up to 2 ³²
Payload Size	0 ... 6291656 Byte
Timestamp	64 bit, resolution in nsec, increment = 8
Packet Delay	0 .. 2 ³² - 1 nsec
Packet Resend	Resend Buffer: 48 MB (8 Images)
GigE Vision	v2.0 (v1.2 backward compatible)



Interfaces and Connectors

Data and Power Interface	Gigabit Ethernet	Transfer Rate	1000 Mbits/sec
	Fast Ethernet	Transfer Rate	100 Mbits/sec
Connector:		8P8C Modular Jack (RJ45), screw lock type	
Assignment:	1 - MX1+	2 - MX1-	
	3 - MX2+	4 - MX3+	
	5 - MX3-	6 - MX2-	
	7 - MX4+	8 - MX4-	
Process Interface	Connector: M8/8-pin		
	(SACC-DSI-M8MS-8CON-M8-L180)		
Assignment:	1 - GPIO (Line2)	2 - Power Vcc	
	3 - IN1 (Line0)	4 - GND IN1	
	5 - Power VCC OUT	6 - OUT1 (Line3)	
	7 - GND (Power, GPIO)	8 - GPIO (Line1)	

Caution



* Note GPIOs: Ground loops are to be avoided and can lead to destruction of the device.

Optical Data

Lens Mount	C-Mount
Optical Filter	-

Mechanical Data

Housing	Zinc die casting, nickel-chrome-plated, IP40 (with mounted lens and GigE cable)
Dimensions	Top view: 40 mm width, 29 mm height, 8.9 mm mounting hole offset, 48.9 mm total width, 20 mm mounting hole offset, 6.6 ±0.35 mm mounting hole diameter. Side view: 29 mm height, 20 mm mounting hole offset, 3 mm mounting hole diameter. Front view: 29 mm height, 20 mm mounting hole offset, 3 mm mounting hole diameter. Mounting holes: 2 x M3 x 4, 8 x M3 x 4, 2 x M2 x 4.5.
Weight	120 g

Environmental Data

Storage Temperature	-10 °C ... + 70 °C
Operating Temperature	+5 °C ... +65 °C @ T = Measurement Point or *) +5 °C ... +72 °C @ internal Temperature Sensor
Int. Temperature	yes, accuracy:
Sensor	±1 °C (typ) 0 °C ... +85 °C
Humidity	10 % ... 90 % non-condensing

*) the maximum temperature for Sony sensor characteristics (sensor performance) are guaranteed up to 50 °C @ Measurement Point or 56 °C @ internal temperature sensor

LED Signalling

LED	Green flash	RX active
	Green	Link ON
	Yellow	Error
	Yellow flash	TX active

Electrical Data

Power Supply (ext.)	VCC: 12 ... 24 V DC $\pm$ 20% I: 107 ... 215 mA
Power over Ethernet	Class 1 device VCC: 36 ... 57 V DC I: 64 mA @ 48 VDC
Power Consumption	approx. 2.6 W @ 12VDC and 39 fps approx. 3.1 W @ 48 VDC (PoE) and 39 fps (Factory Setting "Default")
Digital Input	Optocoupler $U_{IN(low)}$: 0.0 ... 4.5 VDC $U_{IN(high)}$: 11.0 ... 30.0 VDC I_{IN} : 3.0 ... 10.0 mA min. Impulse Length: 2.0 μ sec
Digital Output	Optocoupler U_{EXT} : 5 ... 30 V DC I_{OUT} : max. 50 mA t_{ON} = typ. 3 μ sec t_{OFF} = typ. 40 μ sec
GPIO	direct, without optocoupler
GPIO used as Input:	$U_{IN(low)}$: 0.0 ... 0.8 VDC $U_{IN(high)}$: 2.0 ... 30.0 VDC min. Impulse Length: 2.0 μ sec
GPIO used as Output:	$U_{Out(low)}$: 0.0 ... 0.4 VDC ($I_{sink\ max}$: 50 mA) $U_{Out(high)}$: 2.4 ... 3.3VDC (I_{max} : 1 mA)
Caution	* The General Purpose I/Os (GPIOs) are not potential-free and do not have an overrun cut-off. Incorrect wiring (overvoltage, undervoltage or voltage reversal) can lead to defects in the electronic system. Ground loops are to be avoided and can lead to destruction of the device.

Conformity

Conformity	CE, RoHS, REACH, KC
KC Registration No. / Date	MSIP-REI-BkR-VCXG-51C / 02.05.2017
MTBF	51 years @ T = 45 °C / 33 years @ T = 60 °C T = Measurement Point

GenICam™ Features

Short Exposure Range	yes, ShortExposureTimeEnable Short Exposure Range 1 μ sec ... 60 sec Default Exposure Range 15 μ sec ... 60 sec
Timer	Timer Selector: Timer 1 TimerTriggerSource: Line0, SoftwareTrigger, ExposureStart, ExposureEnd, FrameTransferSkipped, TriggerSkipped, Off TimerDelay: 0 μ sec ... 2 sec, Step Size: 1 μ sec TimerDuration: 4 μ sec ... 2 sec, Step Size: 1 μ sec
Counter	Counter Selector: Counter 1, Counter 2 CounterValue: 0 ... 65535 Counter Event Source: Counter1End or Counter2End, ExposureActive, FrameTransferSkipped, FrameTrigger, TriggerSkipped and Off Counter Reset Source: Counter1End, Counter2End, Line0 and Off
Sequencer	Sequencer Characteristics: up to 128 sets, up to 4 possible pathes for triggered set transitions, 6 trigger sources: Counter1End, Counter2End, ExposureActive, Line0, ReadoutActive, Timer1End Sequencer Parameters for Exposure, Gain, Trigger, ROI and Output: ExposureTime, CounterDuration, CounterEventActivation, CounterEventSource, CounterResetSource, ExposureMode, ExposureTime, Gain, Height, OffsetX, OffsetY, TriggerMode, UserOutputValue, UserOutputValueAll, Width

GenICam™ Features

User Sets	Factory Settings: UserSet0 (read only) Freely Programmable: UserSet1, UserSet2, UserSet3 Parameters: any user definable Parameter
Acquisition Abort	Delay up to 17.8 msec
Chunk Data	yes, Chunk Selector: Binning, Black Level, DeviceTemperature, ExposureTime, FrameID, Gain, Height, Image, ImageControl, LineStatusAll
Device Temperature	InHouse Event generation for Normal to High, High to Exceeded and Exceeded to Normal Exceeded (no image transfer) = max. internal temperature sensor + 1 °C
Device Link Throughput Limit	yes, up to max. Device Link Speed
SFNC Version	v2.3

Factory Settings after Start-Up

Trigger Mode	Off (Free Running)
Analog Controls	Exposure Time: 4 msec, Gain: 0 dB, Offset: 0
Pixel Format	Mono8
Partial Scan	Off
Acquisition Frame Rate	Off
Timer/Counter/Sequencer	Off
Defect Pixel Correction	ON
Fixed Pattern Noise Correction	-
Digital Input	Line0, invert = false
Digital Output	Line3, invert = false, line source = Off
GPIO 1/2	Line1, Line2, invert = false, LineMode = Input
TriggerSource	All

Partial Scan @ FullFrame, min Exposure, Mono8 or BayerRG8

	Resolution	max. fps acquisition	max. fps interface ²⁾
Full HD	1920 x 1080	79	59
SXGA	1280 x 1024	83	83
XGA	1024 x 768	109	109
SVGA	800 x 600	138	138
VGA	640 x 480	170	170
CIF	352 x 288	269	269
QCIF	176 x 144	479	479
LineScan	2048 x 1024	81	57
	2048 x 512	160	117
	2048 x 256	298	236
	2048 x 128	524	471
	2048 x 64	845	845
	2048 x 32	1216	1216
	2048 x 16	1558	1558
	2048 x 8	1815	1815
	2048 x 4	1977	1977
	2048 x 2	2067	2067
	2048 x 1	-	-

²⁾ depends on the used interface

Distribution in the UK & Ireland



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